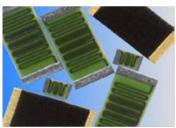
HGC Series	Stackpole Electronics, Inc.
Thick Film Precision High Resistance Chip Resistor	Resistive Product Solutions

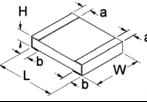
Features:

- Ultra-high stability •
- Very low noise .
- TCR down to 25 ppm/°C
- RoHS compliant and halogen free



	Electrical Specifications											
Type / Code	Power Rating (W) @ 70ºC	Maximum Working Voltage	TCR (ppm/⁰C)	0.1%	Ohmic Range (Ω) and Tolerance				20%			
	@ 70°C	(V)	± 50	0.1%	0.25%	0.5%	1%	2%	5% 0K - 100N	10%	20%	
0402	0.04	50	± 50 ± 100						0K - 100k 0K - 500k			
0402	0.04	50	± 100 ± 200		-		10K - 500M	I		″ K - 1G		
			± 200				10K - 100M		-	- 500M		
0603	0.06	100	± 100			10K - 10M				K - 1G		
0000	0.00	100	± 200				10K - 500M	10K -		10K - 10G	10K - 50G	
			± 50					-	0K - 500N		1011 000	
0805	0.2		± 100	_		10K - 10M	10K - 1G					
	-	-	± 200						10K - 1			10K - 50G
		± 25			1M - 10M			1M -	- 100M			
1000	0.22	200	± 50	100K - 10M	100K - 100M			100K - 500M				
1206	0.33 20	200 ± 100		10K - 10M	10K - 100M	10K - 500M			10K - 1G			
			± 200	± 200		TUK - 500IVI	10K - 1G		10K - 100	à	10K - 50G	
			± 25	1M - 10M			1M ·	- 100M				
2010	1	300	± 50	100K - 10M	100K - 100M			100K - 50	00M			
2010	1	500	± 100	10K - 10M	10K - 100M	10K - 500M			10K - 1G			
			± 200		TOIX = TOOM	1010 - 500101	10K - 1G		10K - 100	3	10K - 50G	
			± 25	1M - 100M			1M ·	- 500M				
2512	2	350	± 50	100K - 100M	100K - 500M			100K - 1	1G		_	
			± 100	10K - 100M	1 10K - 500M 10K - 1G		10)K - 10G		100K		
			± 200							100K	- 50G	
			± 25	1M - 100M	40016 50014		1M ·	- 500M	10			
3512	3	600	± 50	100K - 100M	100K - 500M	1 100K - 1G		40016	400			
			± 100	10K - 100M	10K - 500M	10K - 1G	10)K - 10G		100K		
			± 200							100K	- 50G	

Mechanical Specifications



Type / Code	L	W	H Dadu Haisht (Maul)	a	b Detterr Territortion	Unit
	Body Length 0.040 ± 0.005	Body Width 0.020 ± 0.003	Body Height (Max.) 0.020	Top Termination 0.008 ± 0.004	Bottom Termination 0.010 ± 0.004	inches
0402	1.02 ± 0.13	0.51 ± 0.08	0.51	0.20 ± 0.10	0.25 ± 0.10	mm
0603	0.063 ± 0.010	0.031 ± 0.005	0.020	0.010 ± 0.005	0.012 ± 0.008	inches
	1.60 ± 0.25	0.79 ± 0.13	0.51	0.25 ± 0.13	0.30 ± 0.20	mm
0805	0.079 ± 0.010	0.050 ± 0.005	0.025	0.010 ± 0.005	0.013 ± 0.008	inches
	2.01 ± 0.25	1.27 ± 0.13	0.64	0.25 ± 0.13	0.33 ± 0.20	mm
1206	0.126 ± 0.010	0.063 ± 0.005	0.030	0.010 ± 0.005	0.020 ± 0.010	inches
	3.20 ± 0.25	1.60 ± 0.13	0.76	0.25 ± 0.13	0.51 ± 0.25	mm

This specification may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.

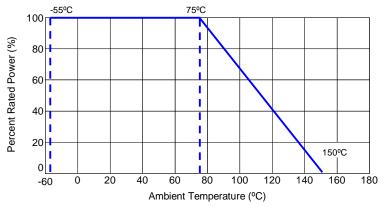
Resistive Product Solutions

	Mechanical Specifications (cont.)								
Type / Code	L Body Length	W Body Width	H Body Height (Max.)	a Top Termination	b Bottom Termination	Unit			
2010	0.200 ± 0.010	0.100 ± 0.005	0.030	0.018 ± 0.010	0.020 ± 0.010	inches			
	5.08 ± 0.25	2.54 ± 0.13	0.76	0.46 ± 0.25	0.51 ± 0.25	mm			
2512	0.250 ± 0.010	0.125 ± 0.005	0.030	0.020 ± 0.010	0.024 ± 0.010	inches			
	6.35 ± 0.25	3.18 ± 0.13	0.76	0.51 ± 0.25	0.61 ± 0.25	mm			
3512	0.350 ± 0.010	0.125 ± 0.005	0.030	0.020 ± 0.010	0.024 ± 0.010	inches			
	8.89 ± 0.25	3.18 ± 0.13	0.76	0.51 ± 0.25	0.61 ± 0.25	mm			

Performance Characteristics Test Typical Delta R Short Time Overload 0.1% Load Life 0.1% **Temperature Cycle** 0.1% Moisture Resistance 0.1% Shock 0.05% Vibration 0.05% **Dielectric Withstanding Voltage** 0.05% Resistance to Soldering Heat 0.05%

Operating temperature range is -55°C to +150°C

Power Derating Curve:



Recommended Solder Profile

This information is intended as a reference for solder profiles for Stackpole resistive components. These profiles should be compatible with most soldering processes. These are only recommendations. Actual numbers will depend on board density, geometry, packages used, etc., especially those cells labeled with "*".

100% Matte Tin / RoHS Compliant Terminations

Soldering iron recommended temperatures: 330°C to 350°C with minimum duration. Maximum number of reflow cycles: 3.

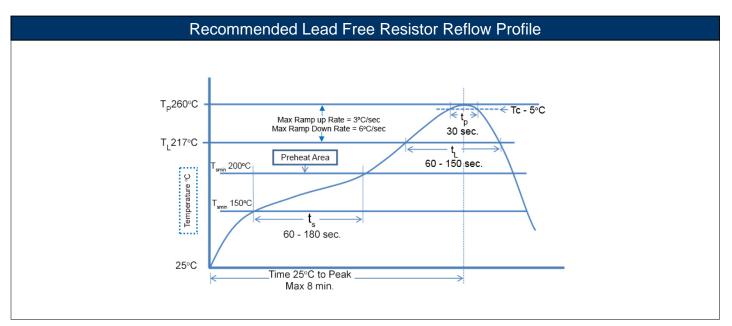
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Resistive Product Solutions

Wave Soldering					
Description	Maximum	Recommended	Minimum		
Preheat Time	80 seconds	70 seconds	60 seconds		
Temperature Diff.	140°C	120°C	100°C		
Solder Temp.	260°C	250°C	240°C		
Dwell Time at Max.	10 seconds	5 seconds	*		
Ramp DN (°C/sec)	N/A	N/A	N/A		

Temperature Diff. = Defference between final preheat stage and soldering stage.

Convection IR Reflow					
Description	Maximum	Recommended	Minimum		
Ramp Up (°C/sec)	3°C/sec	2°C/sec	*		
Dwell Time > 217°C	150 seconds	90 seconds	60 seconds		
Solder Temp.	260°C	245°C	*		
Dwell Time at Max.	30 seconds	15 seconds	10 seconds		
Ramp DN (°C/sec)	6°C/sec	3°C/sec	*		



RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 3). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament as amended by Directive (EU) 2015/863/EU as regards the list of restricted substances.

RoHS Compliance Status								
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)		
HGC	Thick Film Precision High Resistance Chip Resistor	SMD	YES(1)	100% Matte Sn over Ni	Always	Always		

Note (1): RoHS Compliant by means of exemption 7c-I.

This specification may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.

"Conflict Metals" Commitment

We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.

